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Fairchild Semiconductor FMBA14

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**Distributor of Fairchild Semiconductor: Excellent Integrated System Limited** Datasheet of FMBA14 - TRANS NPN DARL 30V 1.2A SSOT-6 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

FMBA14

## FAIRCHILD SEMICONDUCTOR IM FMBA14 C2 E1 C1 **B**2 E2 pin #1 B1 SuperSOT™-6 Mark: .1N Dot denotes pin #1 NPN Multi-Chip Darlington Transistor This device is designed for applications requiring extremely high current gain at collector currents to 1.0 A. Sourced from Process 05. **Absolute Maximum Ratings\*** $T_A = 25^{\circ}C$ unless otherwise noted Symbol 1/-1---11......

Symbol	Parameter	value	Units
V <sub>CES</sub>	Collector-Emitter Voltage	30	V
V <sub>CBO</sub>	Collector-Base Voltage	30	V
V <sub>EBO</sub>	Emitter-Base Voltage	10	V
lc	Collector Current - Continuous	1.2	А
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.
 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### **Thermal Characteristics**

Symbol	Characteristic	Мах	Units
		FMBA14	
PD	Total Device Dissipation	700	mW
	Derate above 25°C	5.6	mW/°C
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	180	°C/W

 $T_A = 25^{\circ}C$  unless otherwise noted

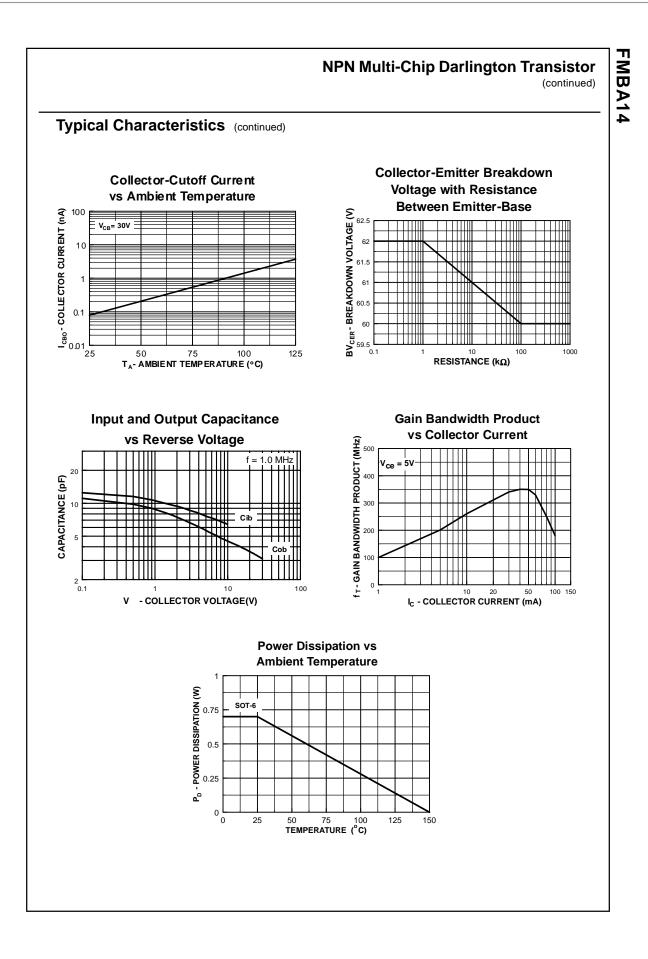
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Electri	cal Characteristics TA=26	NPN Multi-Chip	Darlin	gton		sistor
Symbol	Parameter	5°C unless otherwise noted Test Conditions	Min	Тур	Max	Units
	RACTERISTICS			1		1
	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 100 μA, I <sub>B</sub> = 0	30			V
CBO	Collector-Cutoff Current	$V_{CB} = 30 \text{ V}, \text{ I}_{E} = 0$	50		100	nA
ЕВО	Emitter-Cutoff Current	$V_{EB} = 10 \text{ V}, \text{ I}_{C} = 0$			100	nA
-	ACTERISTICS*		1 1014	1	1	
h <sub>FE</sub>	DC Current Gain	$I_{C} = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$ $I_{C} = 100 \text{ mA}, V_{CE} = 5.0 \text{ V}$	10K 20K			
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_{\rm C} = 100$ mA, $I_{\rm B} = 0.1$ mA			1.5	V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	$I_{C}$ = 100 mA, $V_{CE}$ = 5.0 V			2.0	V
h <sub>fe</sub> *Pulse Test: F	Small Signal Current Gain Pulse Width ≤ 300 µs, Duty Cycle ≤ 2.0%	$I_{C} = 10 \text{ mA}, V_{CE} = 5.0 \text{ V},$ f = 100 MHz				
6) NI 250	Typical Pulsed Current Gain vs Collector Current	Collector-E ≳ Voltage vs			tion	
h <sub>Fe</sub> - TYPICAL PULSED CURRENT GAIN (i) 000 000 0000	$V_{cE} = 5V$ 25 °C -40 °C 10001 $1_{c} - COLLECTOR CURRENT (A)$	$\sum_{i=1}^{n} Voltage vs$	25°C	122	5 °C	1000

FMBA14







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E <sup>2</sup> CMOS <sup>™</sup>	MICROWIRE™	SILENT SWITCHER <sup>®</sup>	
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FACT™	OPTOPLANAR™	SuperSOT <sup>™</sup> -3	
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